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PTO-1595

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U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 04805.0216
Attorney Customer Number: 22,852

ATTN. BOX ASSIGNMENTS RECORDATION
SERVICES

To the Honorable Commissioner of
Please record the attached original

1. Name of conveying party:

Sang Bum LEE

2. Name and address of receiving party:

Name: DongbuAnam Semiconductor Inc.

Additional name of conveying party attached? Yes No

Internal Address:

3. Nature of conveyance:

Street Address: 891-10 Daechi-dong, Gangnam-gu,
Seoul, Korea

Assignment Merger

City:

Security Agreement Change of Name

State:

Zip Code:

Other:

Additional name & Address attached?

Execution Date:

December 20, 2004

Yes

No

4. Application number or patent number: If this document is being filed together with a new application, the execution date of the application: December 20, 2004

A. Patent Application Number:

B. Patent Number:

Additional numbers attached?

Yes

No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)

Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 1300 I Street, N.W.

City: Washington, D.C.

State: Zip: 20005-3315

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ernest F. Chapman
Reg. No. 25,961

Signature

December 29, 2004

Date

Total number of pages including cover sheet, attachments and documents: 3

12-29-04

112847 U.S. PTO
11/024176



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ASSIGNMENT

WHEREAS, I, the below named inventor, (hereinafter referred to as Assignor), have made an invention entitled:

METHOD FOR FABRICATING SEMICONDUCTOR DEVICE

for which I executed an application for United States Letters Patent concurrently herewith or on _____ or filed an application for United States Letters Patent on _____ (Serial No. _____); and

WHEREAS, DongbuAnam Semiconductor Inc., a corporation of Korea, whose post office address is 891-10 Daechi-dong, Gangnam-gu, Seoul, Korea (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application,

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I, as assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I HEREBY authorize and request the attorneys I have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____ filed _____) the filing date and application number of said application when known.

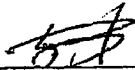
FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Assignor

Sang Bum LEE
206-507 Hanhwa Apt., Sangok2-dong,
Bupyong-gu, Incheon, Korea

Citizenship: Republic of Korea

Signature: 

Date: Dec. 20, 2004

FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.